TOSHIBA PHOTOCOUPLER IRED & PHOTO-DIODE ARRAY

TLP3902

SOLID STATE RELAY PROGRAMMABLE CONTROLLERS MOSFET GATE DRIVER

The TOSHIBA mini flat coupler TLP3902 is a small outline coupler, suitable for surface mount assembly.

The TLP3902 consists of an \inf rared emitting diode, optically coupled to a series connected photo diode array which is suitable for MOS FET gate drive.

Features

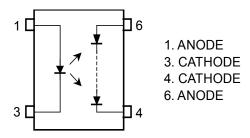
Open Voltage : 7 V (min)
 Short Current : 5 µA (min)
 Isolation Voltage : 2500 Vrms (min)

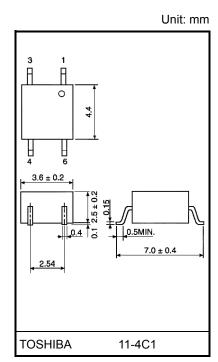
UL-recognized : UL 1577, File No.E67349

cUL-recognized :CSA Component Acceptance Service No.5A

File No.E67349

Pin Configuration (top view)





Weight: 0.09 g (typ.)

Start of commercial production 2006-06

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
	Forward Current	lF	50	mA
	Forward Current Derating (Ta ≥ 25°C)	ΔIF / °C	-0.5	mA / °C
LED	Reverse Voltage	VR	5	V
LED	Diode power dissipation	PD	100	mW
	Diode power dissipation derating (Ta ≥ 25°C)	ΔP _D /°C	-1.0	mW/°C
	Junction Temperature	Tj	125	°C
	Forward Current	lFD	50	μΑ
DETECTOR	Reverse Voltage	V _{RD}	10	V
DETECTOR	Output power dissipation	Po	0.5	mW
	Junction Temperature	Tj	125	°C
Storage Temperature Range		T _{stg}	-55 to 125	°C
Operating Temperature Range		T _{opr}	-40 to 85	°C
Lead Soldering Temperature (10 s)		T _{sol}	260	°C
Isolation Volta	age (AC, 60 s, R.H. ≤ 60 %) (Note 1)	BVS	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two terminal device: Pins 1 and 3 shorted together and pins 4 and 6 shorted together.

Recommended Operating Conditions

Characteristic	Symbol	Min	Тур.	Max	Unit
Forward Current	lF	7	_	20	mA
Operating Temperature	Topr	-25	_	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward Voltage	VF	IF = 10 mA	1.10	1.15	1.3	V
LED	Reverse Current	I _R	V _R = 5 V	_	_	10	μΑ
	Capacitance	Ст	V = 0 V, f = 1 MHz	_	30	_	pF
	Forward Voltage	V _{FD}	I _{FD} = 10 μA	_	9.6	_	V
DETECTOR	Reverse Current	IRD	V _{RD} = 10 V	_	1	_	nA
	Capacitance (Anode to Cathode)	C _{TD}	V = 0 V, f = 1 MHz	-	8	1	pF

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Open-Circuit Voltage	Voc	I _F = 10 mA	7	9.5	_	V
Short-Circuit Current	Isc	I _F = 10 mA	5	10	_	μA

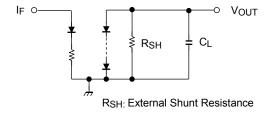
Isolation Characteristics (Ta = 25°C)

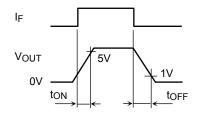
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance Input to Output	Cs	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation Resistance	Rs	V _S = 500 V, R.H. ≤ 60 %	5×10 ¹⁰	10 ¹⁴	_	Ω
Isolation Voltage	BVs	AC, 60 s	2500	_	_	Vrms

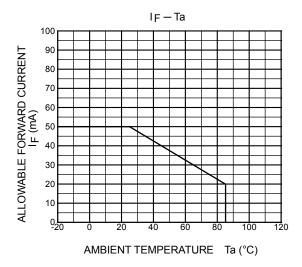
Switching Characteristics (Ta = 25°C)

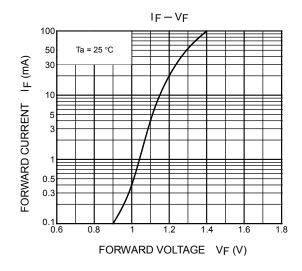
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on Time	ton	IF = 10 mA, R _{SH} = 1 M Ω	_	0.6	_	ms
Turn-off Time	toff	C _L = 1000 pF (Note 2)	_	2	_	ms

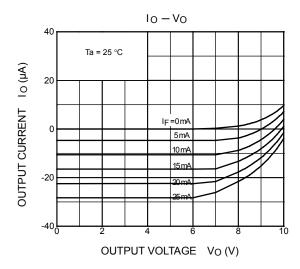
Note 2: SWITCHING TIME TEST CIRCUIT

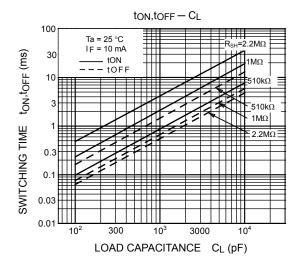


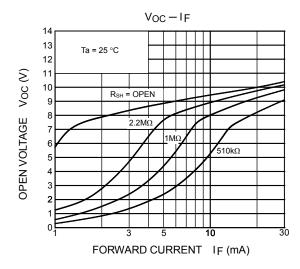


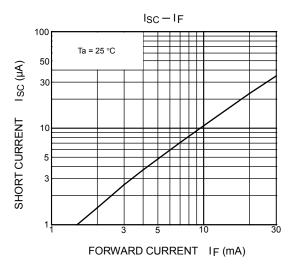




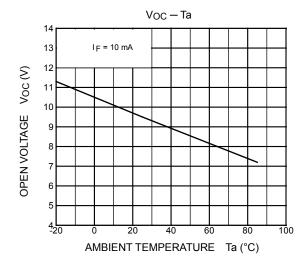


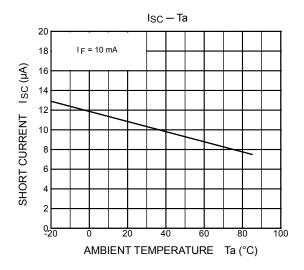






NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.





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